02-06-06

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



DEP & REF

PAIL:

## **PATENT**

2004 FEB 10 101 4: 41

US PATENT & TRADEWARK OFFICE

## PAIE

Application No.:

09/945,241

Filing Date:

August 31, 2001

Applicants:

Fumiaki Matsushima, et al.

Group Art Unit:

2815

Examiner:

Jasmine J.B. Clark

Title:

METHOD FOR FORMING A BUMP, SEMICONDUCTOR DEVICE AND METHOD OF FABRICATING SAME, SEMICONDUCTOR CHIP, CIRCUIT BOARD, AND

**ELECTRONIC INSTRUMENT** 

Attorney Docket:

93191-000277

Commissioner of Patents and Trademarks Washington, D.C. 20231

## **REQUEST FOR REFUND**

Sir:

The issue fee payment of \$1,685.00 was forwarded to the U.S. PTO on December 6, 2004 and Deposit Account 50-3213 was debited for that amount. Applicants withdrew the application from issue and have subsequently abandoned this application.

Therefore, please credit Deposit Account 50-3213 in the amount \$1,685.00 at your earliest convenience.

Favorable consideration of this request is respectfully requested.

Respectfully submitted,

Dated: February 3, 2006

6. Gregory Schivle

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